

Multilayer Ceramic Chip Capacitors

CGA2B3X7R1H473M050BE



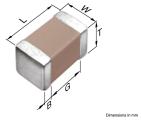






TDK item description CGA2B3X7R1H473MT***S

Applications	Automotive Grade	
Feature	Soft Termination AEC-Q200 AEC-Q200	
Series	CGA2(1005) [EIA 0402]	
Status	Production	



Size		
Length(L)	1.00mm +0.15,-0.05mm	
Width(W)	0.50mm +0.10,-0.05mm	
Thickness(T)	0.50mm +0.10,-0.05mm	
Terminal Width(B)	0.10mm Min.	
Terminal Spacing(G)	0.30mm Min.	
Recommended Land Pattern (PA)	0.30mm to 0.50mm	
Recommended Land Pattern (PB)	0.35mm to 0.45mm	
Recommended Land Pattern (PC)	0.40mm to 0.60mm	

Electrical Characteristics		
Capacitance	47nF ±20%	
Rated Voltage	50VDC	
Temperature Characteristic	X7R(±15%)	
Dissipation Factor (Max.)	5%	
Insulation Resistance (Min.)	10000ΜΩ	

Other	
Soldering Method	Reflow
AEC-Q200	Yes
Packing	Punched (Paper)Taping [180mm Reel]
Package Quantity	10000pcs

[!] Images are for reference only and show exemplary products. ! This PDF document was created based on the data listed on the TDK Corporation website.

[!] All specifications are subject to change without notice.

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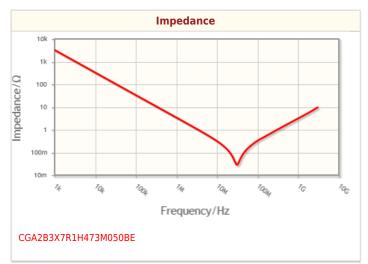


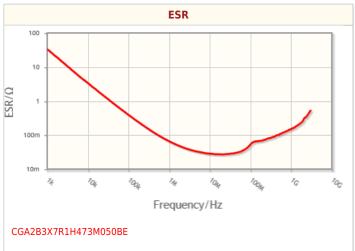


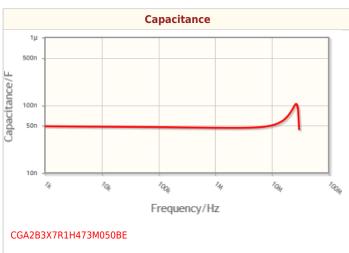


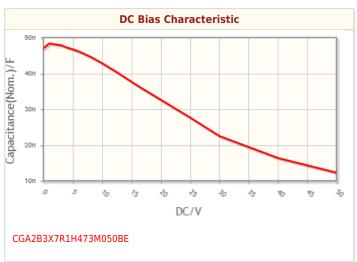


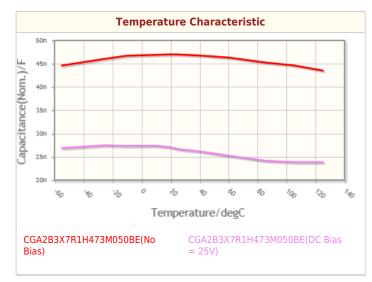
Characteristic Graphs(This is reference data, and does not guarantee the products characteristics.)

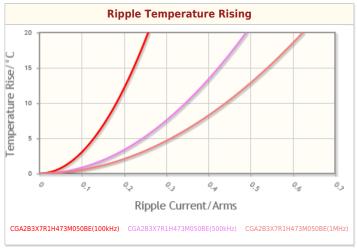












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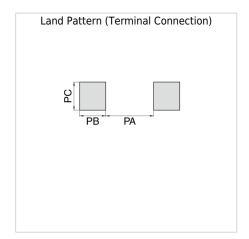








Associated Images



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